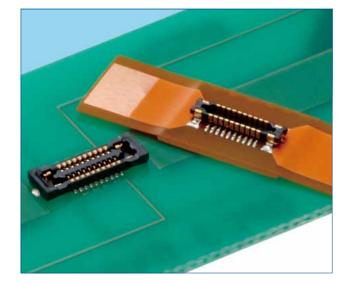
0.35mm Pitch 0.8mm Height Hybrid Power/Signal Connectors for Board-to-Board and FPC-to-Board

contacts)

BM24 Series



Features

1. Rated current : 5A

The compact BM24 Series features a space-saving design with the power contacts rated at 5A, and the signal contact rated at 0.25A. (Fig.1)

2. High contact reliability

A 2-point contact structure for both power and signal contacts provides high contact reliability. (Fig.3)

3. Enhanced mating process

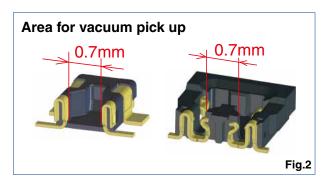
A guide rib ensures self-alignment during mating, with an alignment range of 0.3mm. In addition, a tactile click is generated upon mating completion, preventing incomplete mating and enhancing mating operability.

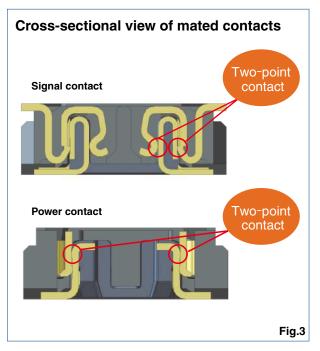
4. Supports USB3.0/3.1 transmission

The signal contact supports USB3.0/3.1 signals.

Conventional type (P= 0.35 mm, 20 contacts) When using a 1.5 A power supply BM24 with 10 contact positions (Plus two power

By consolidating the power to two dedicated power pins, the BM24's hybrid power/signal design saves valuable PCB space over conventional signal contact only style connectors. Fig.1





(Supports USB3.0 signal)



Product Specifications

Datingo	Rated current	Power contact : 5A Signal contact : 0.25A(Note 1)	Operating temperature range	-40 to 85°C (Note 2)	Storage temperature range	-10 to 60℃ (Note 3)
Ratings	Rated voltage	30V AC/DC	Operating humidity range	20 to 80%	Storage humidity range	40 to 70% (Note 3)

Items	Specifications	Conditions
1. Insulation resistance	100MΩ min.	Measured at 100V DC
2. Withstanding voltage	No flashover or dielectric breakdown	150V AC for one minute
3. Contact resistance	Signal contact : $100m\Omega$ max. Power contact : $15m\Omega$ max.	Measured at 20mV AC, 1kHz, and 1mA
4. Vibration	No electrical discontinuity for more than 1μ s.	Frequency : 10 to 55 Hz ; half amplitude : 0.75mm, in 3 axis directions for 2 hours
5. Humidity	Contact resistance : Signal contact : $100m\Omega$ max. Power contact : $15m\Omega$ max. Insulation resistance : $50M\Omega$ min.	96 hours at a temperature of 40 $\pm 2^\circ\!\!C$ and a humidity range from 90 to 95%
6. Temperature cycle	Contact resistance : Signal contact : $100m\Omega$ max. Power contact : $15m\Omega$ max. Insulation resistance : $100M\Omega$ min.	(-55 [°] C for 30 minutes → 5 to 35 [°] C for 10 minutes → 85 [°] C for 30 minutes → 5 to 35 [°] C for 10 minutes) in 5 cycles
7. Durability	Contact resistance : Signal contact : $100m\Omega$ max. Power contact : $15m\Omega$ max.	10 mating cycles
8. Solder heat No dissolution or melting of the resin that will affect the performance.		Reflow : with recommended temperature profile ; Hand soldering at soldering iron temperature of 350°C for 3 seconds max.

Note 1 : The total current capacity for connectors with 40 or more signal contacts is 10A for all contacts.

Note 2 : Includes temperature rise caused by current flow.

Note 3 : Storage refers to long-term-storage of unused items before they are mounted on the PCB. Operating temperature / humidity range applies to the state of temporary storage such as non-powered after mounting on the PCB, and during transportation, etc.

Materials / Finish

Product	Part	Materials Finish		UL Regulation
	Insulator LCP		Black	UL94V-0
Receptacle Header	Signal contact	Phosphor bronze	Gold plated	
	Power contact	Copper alloy	Gold plated	

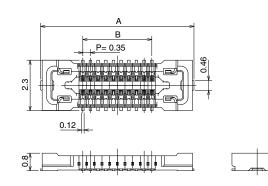
Product Number Structure

Refer to the chart below when determining the product specifications from the product number. Please select from the product numbers listed in this catalog when placing orders.

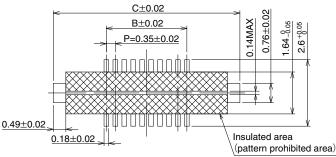
Receptacle / Header

$\frac{BM}{0} \frac{24}{2} - \frac{*}{6} \frac{DS}{6} / \frac{2}{6}$	$- \frac{0.35}{6} \frac{V}{6} \frac{(51)}{3}$		
Series Name : BM	Number of Power Contacts : 2		
2 Series No. : 24	6 Contact Pitch : 0.35mm		
3 Number of Signal Contacts : 10, 20, 24, 30, 40	Termination typeV : Straight SMT		
 Connector type DS : Receptacle DP : Header 	 Gold plated specification and packaging status (51) : Gold plate thickness 0.05µm Embossed tape packaging (10,000 pcs/reel) 		

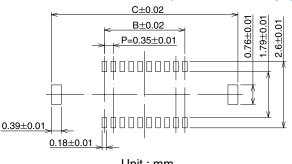
Receptacle



Recommended PCB layout



Recommended metal mask dimensions (mask thickness : 100 μm)

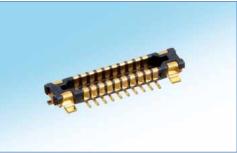


				U	nıt : mm
Part No.	HRS No.	No. of Contacts	A	В	С
BM24-10DS/2-0.35V(51)	677-2002-1 51	10	5.25	1.4	5.55
BM24-20DS/2-0.35V(51)	677-2004-7 51	20	7	3.15	7.3
BM24-24DS/2-0.35V(51)	677-2006-2 51	24	7.7	3.85	8
BM24-30DS/2-0.35V(51)	677-2008-8 51	30	8.75	4.9	9.05
BM24-40DS/2-0.35V(51)	677-2010-0 51	40	10.5	6.65	10.8

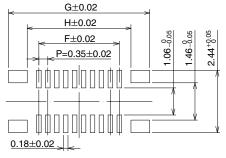
Note 1 : Please place orders in full reel quantities.

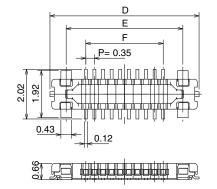
Note 2 : This connector has no polarity.

Header

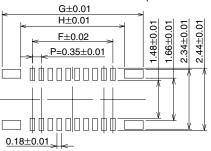


Recommended PCB layout





Recommended metal mask dimensions (mask thickness : 100 μm)



Unit : mm

Part No.	HRS No.	No. of Contacts	D	E	F	G	Н
BM24-10DP/2-0.35V(51)	677-2001-9 51	10	4.32	3	1.4	3.73	2.27
BM24-20DP/2-0.35V(51)	677-2003-4 51	20	6.07	4.75	3.15	5.48	4.02
BM24-24DP/2-0.35V(51)	677-2005-0 51	24	6.77	5.45	3.85	6.18	4.72
BM24-30DP/2-0.35V(51)	677-2007-5 51	30	7.82	6.5	4.9	7.23	5.77
BM24-40DP/2-0.35V(51)	677-2009-0 51	40	9.57	8.25	6.65	8.98	7.52

Note 1 : Please place orders in full reel quantities.

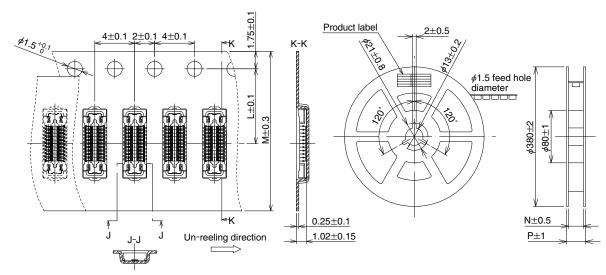
Note 2 : This connector has no polarity.



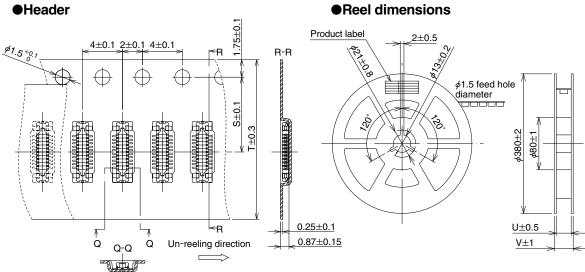
Embossed Tape Dimensions (complies with JIS C 0806)

Receptacle

Reel dimensions



					Unit : mm
Part No.	No. of Contacts	L	М	N	Р
BM24-10DS/2-0.35V(51)	10				
BM24-20DS/2-0.35V(51)	20	7.5	16	17.5	21.5
BM24-24DS/2-0.35V(51)	24				
BM24-30DS/2-0.35V(51)	30	11 5	24	05 F	20 F
BM24-40DS/2-0.35V(51)	40	11.5	24	25.5	29.5



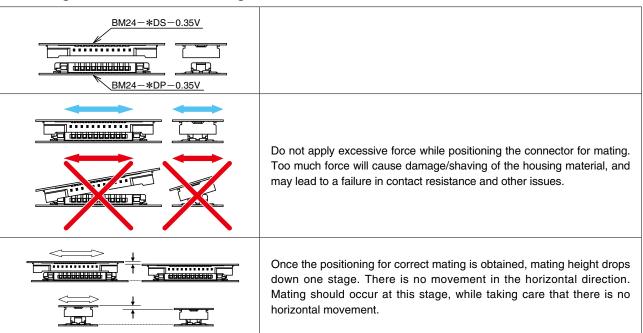
					Unit : mm
Part No.	No. of Contacts	S	Т	U	V
BM24-10DP/2-0.35V(51)	10				
BM24-20DP/2-0.35V(51)	20	7.5	16	17.5	21.5
BM24-24DP/2-0.35V(51)	24				
BM24-30DP/2-0.35V(51)	30	44 5	0.4	05.5	00.5
BM24-40DP/2-0.35V(51)	40	11.5	24	25.5	29.5

Reel dimensions

Precautions

1.Recommended solder	MAX 250°C				
temperature profile	250				
	220				
	Q 200 Within 60 seconds				
	2200 Part 150				
	a a a a a a a a a a a a a a a a a a a				
	100 - 90 to 120 sec				
	50 -				
	Room				
	temperature				
	0 50 100 150 200 250 300				
	[Conditions] Heating time (sec)				
	1. Peak temperature : Maximum of 250°C				
	2. Heat section : 220°C min., within 60 seconds				
	3. Preheat section : 150 to 180°C, 90 to 120 seconds				
	4. Number of reflow cycles : Maximum of 2 cycles				
	Note 1 : The temperature refers to the surface temperature of the PCB in the				
	area of the connector lead.				
	Note 2 : When you use nitrogen reflow, please mount the product with the				
	oxygen concentration at a minimum of 1,000 ppm.				
	Please contact us if the concentration is below 1,000 ppm.				
2. Recommended manual	Soldering iron temperature: $340 \pm 10^{\circ}$ C ;				
soldering conditions	Soldering time: within 3 seconds				
	-				
3. Recommended stencil	Thickness: 0.1mm				
thickness and open area	Aperture ratio : 80% on the DS side ; 70% on the DP side				
ratio to PCB pattern area					
4 Roard warpage	A maximum of 0.02mm at the center of the connector relative to each end of				
4. Board warpage	the connector.				
5. Cleaning conditions	Cleaning is not recommended. If you clean this product, please evaluate its				
5. Cleaning conditions	performance before using it.				
	(Cleaning may impair the mating/unmating properties and lower resistance to				
	environmental factors)				
	•Care should be taken when mating/unmating the connector when it is not				
	mounted on the PCB. This could cause damage or deformation of the contacts.				
6. Precautions	•Avoid supporting the PCB only with the connectors.				
	Support it by other means such as bolts, screws, posts, etc.				
	•Care should be taken that excessive prying mating/unmating could cause				
	damage.				
	• In the appendix hand coldering places do not apply any flux, which could				
	In the case of hand soldering, please do not apply any flux, which could acues flux wicking				
	cause flux wicking.				
	cause flux wicking. This product may have slight color differences due to production lot				
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Handling Precautions when Mating Connectors



Handling Precautions when Un-mating Connectors

BM24-*DS-0.35V BM24-*DP-0.35V	
	Be sure to unmate the connectors in a straight line direction.
Pitch orientation Correct	If you are unable to unmate a cnnector in straight line direction due to a handling issue, pull it out in an oblique direction as shown in the figure on the left. However, the connector could be broken if there is not enough support on the FPC. Please account for this during prototyping.
Corner orientation Incorrect	Unmating a connector by a corner, as shown in the figure to the left, could damage the connector and contacts. Never disconnect connectors using a corner.
	Make sure that the FPC has a stiffener of sufficient strength. If the stiffener is not strong enough, the connector could be broken, as shown in the figure on the left. It is advised to test the FPCs strength by repeated mating/unmating cycles. We recommend the use of a glass epoxy material with a minimum thickness of 0.3mm, or a stainless steel material with a minimum thickness of 0.2mm.



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The characteristics and the specifications contained herein are for reference purpose. Please refer to the latest customer drawings prior to use. The contents of this catalog are current as of date of 03/2016. Contents are subject to change without notice for the purpose of improvements.